

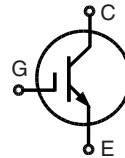
# IGBT with optional Diode

High Speed,  
Low Saturation Voltage

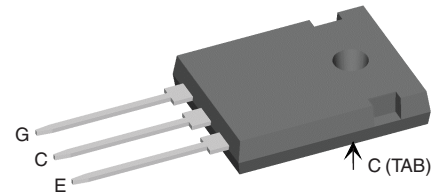
## Replacement Types

**IXXH30N60B3**  
**IXYH30N65C3**

$V_{CES} = 600\text{ V}$   
 $I_{C25} = 60\text{ A}$   
 $V_{CE(sat) typ} = 2.1\text{ V}$



TO-247 AD



Gate, Emitter, Collector, TAB = Collector

Symbol	Conditions	Maximum Ratings	
$V_{CES}$	$T_J = 25^\circ\text{C to } 150^\circ\text{C}$	600	V
$V_{CGR}$	$T_J = 25^\circ\text{C to } 150^\circ\text{C}; R_{GE} = 20\text{ k}\Omega$	600	V
$V_{GES}$	Continuous	$\pm 20$	V
$V_{GEM}$	Transient	$\pm 30$	V
$I_{C25}$	$T_C = 25^\circ\text{C}$	60	A
$I_{C90}$	$T_C = 90^\circ\text{C}$	35	A
$I_{CM}$	$T_C = 90^\circ\text{C}, t_p = 1\text{ ms}$	70	A
<b>RBSOA</b>	$V_{GE} = \pm 15\text{ V}, T_J = 125^\circ\text{C}, R_G = 10\ \Omega$ Clamped inductive load, $L = 30\ \mu\text{H}$	$I_{CM} = 110$ $V_{CEK} < V_{CES}$	A
<b><math>t_{SC}</math> (SCSOA)</b>	$V_{GE} = \pm 15\text{ V}, V_{CE} = 600\text{ V}, T_J = 125^\circ\text{C}$ $R_G = 10\ \Omega$ , non repetitive	10	$\mu\text{s}$
$P_C$	$T_C = 25^\circ\text{C}$	IGBT	250 W
		Diode	80 W
$T_J$		-55 ... +150	$^\circ\text{C}$
$T_{stg}$		-40 ... +150	$^\circ\text{C}$
Maximum lead temperature for soldering 1.6 mm (0.062 in.) from case for 10 s		300	$^\circ\text{C}$
$M_d$	Mounting torque	TO-220	0.4 - 0.6 Nm
		TO-247	0.8 - 1.2 Nm
<b>Weight</b>		6	g

### Features

- NPT IGBT technology
- low switching losses
- low tail current
- no latch up
- short circuit capability
- positive temperature coefficient for easy paralleling
- MOS input, voltage controlled
- optional ultra fast diode
- International standard package

### Advantages

- Space savings
- High power density

### Typical Applications

- AC motor speed control
- DC servo and robot drives
- DC choppers
- Uninterruptible power supplies (UPS)
- Switch-mode and resonant-mode power supplies

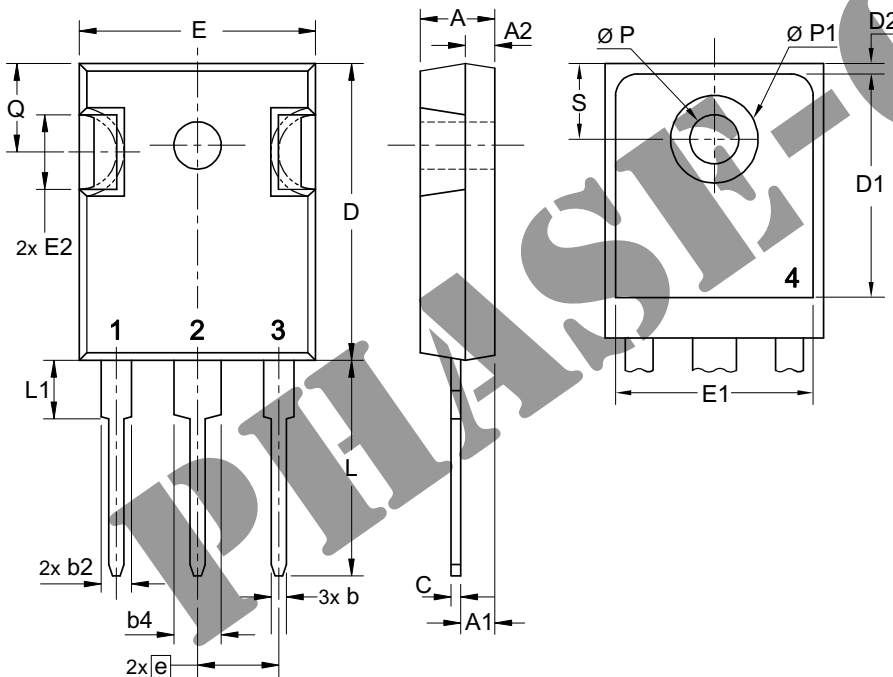
Symbol	Conditions	Characteristic Values ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)		
		min.	typ.	max.
$V_{(BR)CES}$	$V_{GE} = 0\text{ V}$	600		V
$V_{GE(th)}$	$I_C = 0.7\text{ mA}, V_{CE} = V_{GE}$	3		V
$I_{CES}$	$V_{CE} = V_{CES}$			$T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$ 0.1 mA mA
$I_{GES}$	$V_{CE} = 0\text{ V}, V_{GE} = \pm 20\text{ V}$			$\pm 500\text{ nA}$
$V_{CE(sat)}$	$I_C = 35\text{ A}, V_{GE} = 15\text{ V}$	2.2	2.7	V

IXYS reserves the right to change limits, test conditions and dimensions.

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Symbol	Conditions	Characteristic Values		
		(T <sub>J</sub> = 25°C, unless otherwise specified)		
		min.	typ.	max.
C <sub>ies</sub>	V <sub>CE</sub> = 25 V, V <sub>GE</sub> = 0 V, f = 1 MHz		1600	pF
C <sub>oes</sub>			150	pF
C <sub>res</sub>			90	pF
Q <sub>g</sub>	I <sub>C</sub> = 35 A, V <sub>GE</sub> = 15 V, V <sub>CE</sub> = 480 V		120	nC
t <sub>d(on)</sub>	Inductive load, T <sub>J</sub> = 125°C I <sub>C</sub> = 35 A, V <sub>GE</sub> = ±15 V, V <sub>CE</sub> = 300 V, R <sub>G</sub> = 10 Ω		30	ns
t <sub>r</sub>			45	ns
t <sub>d(off)</sub>			320	ns
t <sub>f</sub>			70	ns
E <sub>on</sub>			1.6	mJ
E <sub>off</sub>			0.8	mJ
R <sub>thJC</sub>				0.5 K/W
R <sub>thCH</sub>	TO 247 Package with heatsink compound		0.25	K/W
R <sub>thCH</sub>	TO 220 Package with heatsink compound		0.5	K/W

Symbol	Conditions	Characteristic Values		
		(T <sub>J</sub> = 25°C, unless otherwise specified)		
		min.	typ.	max.
V <sub>F</sub>	I <sub>F</sub> = 35 A, V <sub>GE</sub> = 0 V	2.1	2.4	V
	I <sub>F</sub> = 35 A, V <sub>GE</sub> = 0 V, T <sub>J</sub> = 125°C	1.6		V
I <sub>F</sub>	T <sub>C</sub> = 25°C		45	A
	T <sub>C</sub> = 90°C		25	A
I <sub>RM</sub>	I <sub>F</sub> = 15 A, -di <sub>F</sub> /dt = 400 A/μs, V <sub>R</sub> = 300 V		13	A
t <sub>rr</sub>	V <sub>GE</sub> = 0 V, T <sub>J</sub> = 125°C		90	ns
t <sub>rr</sub>	I <sub>F</sub> = 1 A, -di <sub>F</sub> /dt = 100 A/μs, V <sub>R</sub> = 30 V, V <sub>GE</sub> = 0 V		40	ns
R <sub>thJC</sub>				1.6 K/W

**TO-247 AD Outline**


Sym.	Inches		Millimeter	
	min.	max.	min.	max.
A	0.185	0.209	4.70	5.30
A1	0.087	0.102	2.21	2.59
A2	0.059	0.098	1.50	2.49
D	0.819	0.845	20.79	21.45
E	0.610	0.640	15.48	16.24
E2	0.170	0.216	4.31	5.48
e	0.215 BSC		5.46 BSC	
L	0.780	0.800	19.80	20.30
L1	-	0.177	-	4.49
Ø P	0.140	0.144	3.55	3.65
Q	0.212	0.244	5.38	6.19
S	0.242 BSC		6.14 BSC	
b	0.039	0.055	0.99	1.40
b2	0.065	0.094	1.65	2.39
b4	0.102	0.135	2.59	3.43
c	0.015	0.035	0.38	0.89
D1	0.515	-	13.07	-
D2	0.020	0.053	0.51	1.35
E1	0.530	-	13.45	-
Ø P1	-	0.29	-	7.39

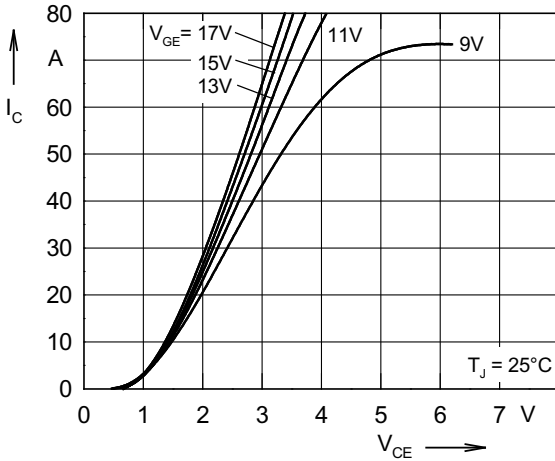


Fig. 1 Typ. output characteristics

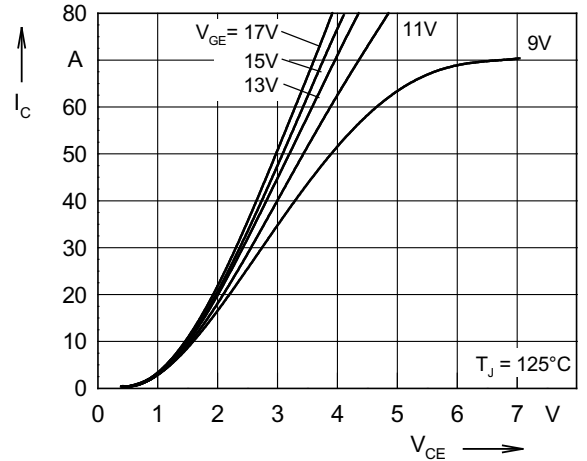


Fig. 2 Typ. output characteristics

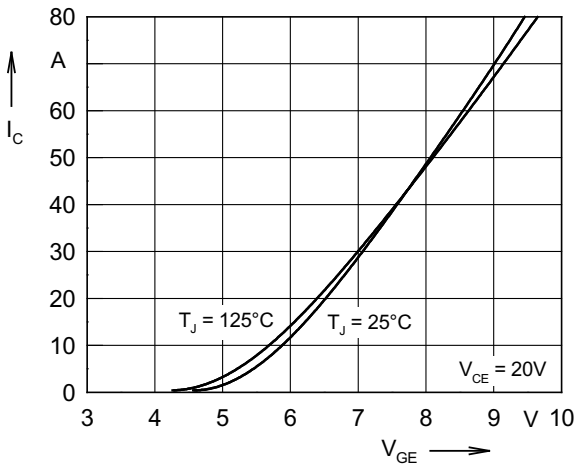


Fig. 3 Typ. transfer characteristics

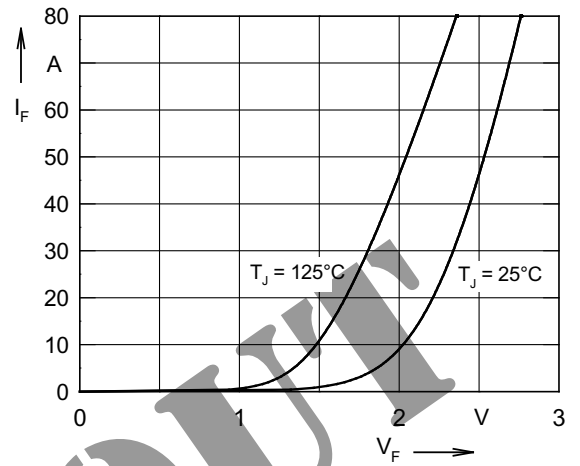


Fig. 4 Typ. forward characteristics of free wheeling diode

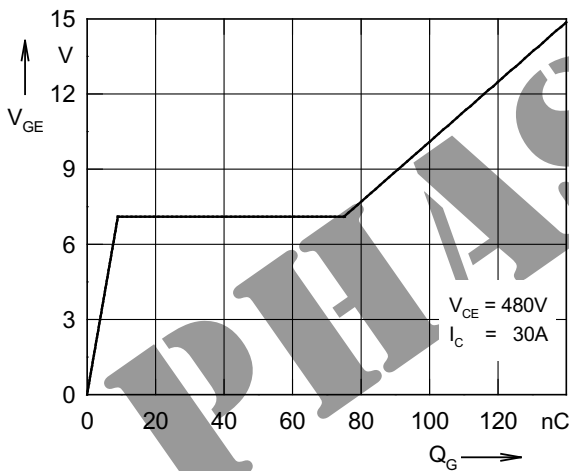


Fig. 5 Typ. turn on gate charge

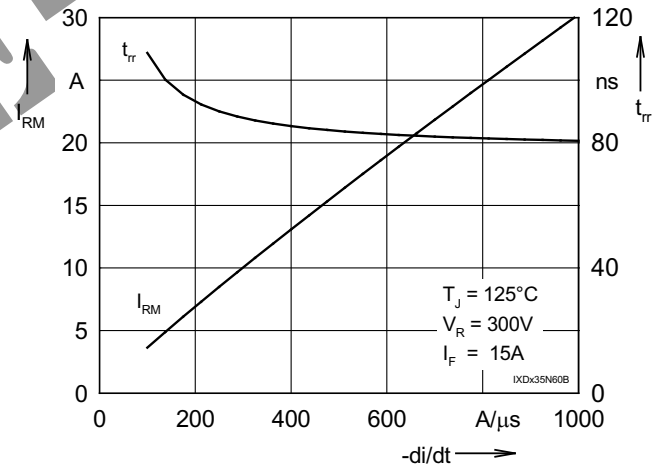


Fig. 6 Typ. turn off characteristics of free wheeling diode

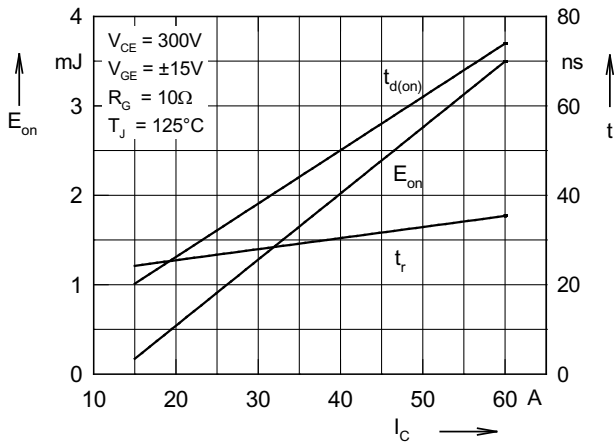


Fig. 7 Typ. turn on energy and switching times versus collector current

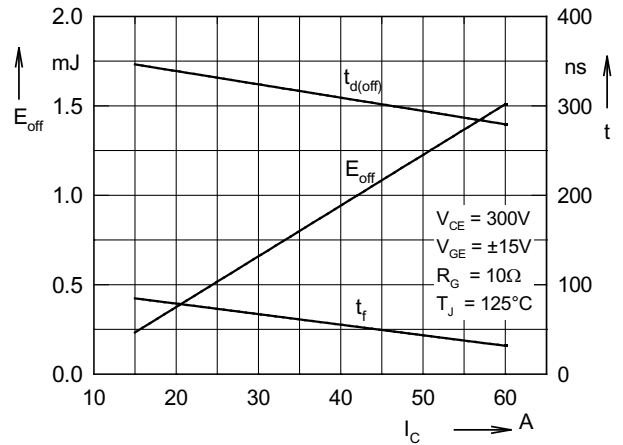


Fig. 8 Typ. turn off energy and switching times versus collector current

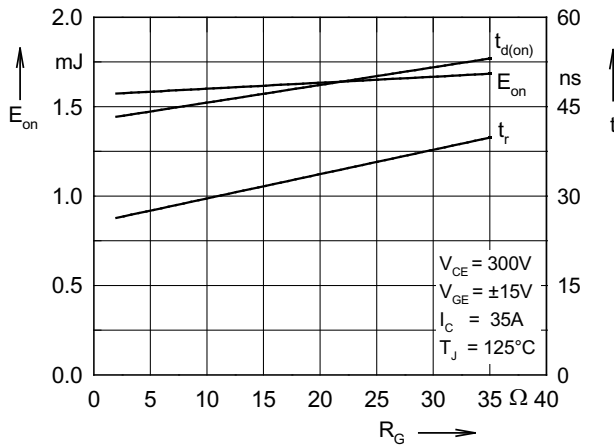


Fig. 9 Typ. turn on energy and switching times versus gate resistor

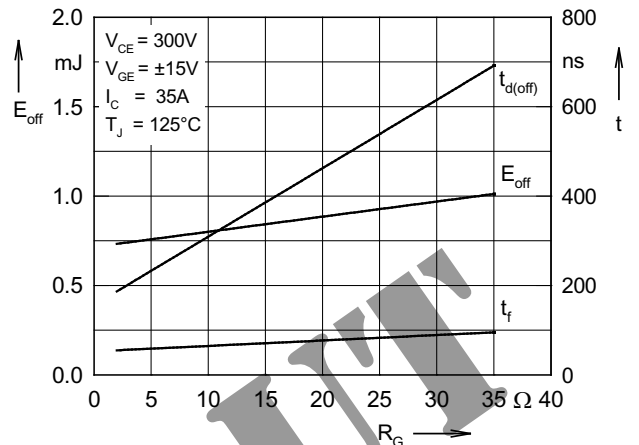


Fig. 10 Typ. turn off energy and switching times versus gate resistor

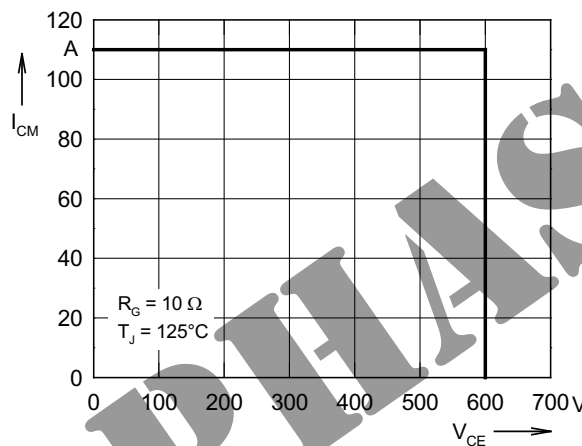


Fig. 11 Reverse biased safe operating area RBSOA

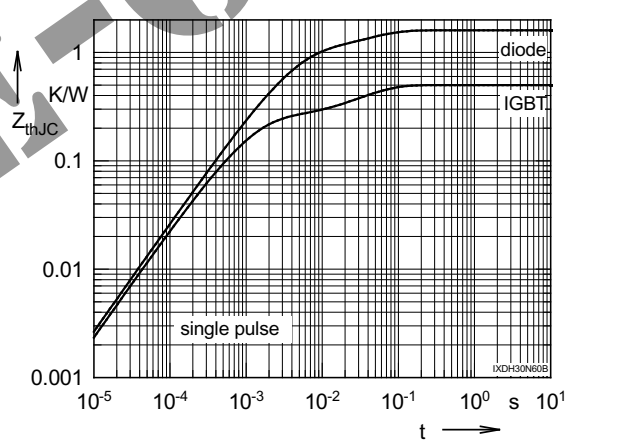


Fig. 12 Typ. transient thermal impedance